



MOSFET

OptiMOS[™] 5 Power-Transistor, 25 V

Features

- Optimized for OR-ing application
- Very low on-resistance $R_{DS(on)}$ @ V_{GS} =4.5 V 100% avalanche tested Superior thermal resistance

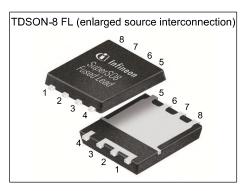
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

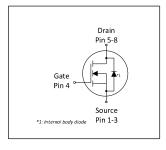
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

| Parameter | Value | Unit |
|-------------------------|-------|------|
| V _{DS} | 25 | V |
| R _{DS(on),max} | 0.45 | mΩ |
| ID | 479 | A |
| Q _{oss} | 70 | nC |
| Q _G (0V4.5V) | 135 | nC |









| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|---------------|----------|---------------|
| BSC004NE2LS5 | PG-TDSON-8 FL | 04NE2LS5 | - |



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

| Demonsterne (dem | 0hl | | Values | | | |
|--|--------------------------|------|--------|------------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | | | 479 338 40 | A | V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =4.5V, T_{A} =25°C, R_{thJA} =50°C/W ²) |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 1914 | А | <i>T</i> _A =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E _{AS} | - | - | 400 | mJ | I _D =20 A, R _{GS} =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 188 2.5 | w | $T_{\rm C}=25 \ ^{\circ}{\rm C}$ $T_{\rm A}=25 \ ^{\circ}{\rm C}, \ R_{\rm thJA}=50 \ ^{\circ}{\rm C/W}^{2)}$ |
| Operating and storage temperature | $T_{\rm j}, T_{\rm stg}$ | -55 | - | 175 | °C | IEC climatic category; DIN IEC 68-1: 55/175/56 |

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|---|-------------------|--------|------|------|------|-----------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case, bottom | $R_{ m thJC}$ | - | - | 0.8 | °C/W | - |
| Thermal resistance, junction - case, top | R _{thJC} | - | - | 20 | °C/W | - |
| Device on PCB, 6 cm² cooling area | R _{thJA} | - | - | 50 | °C/W | - |

³⁾ See Diagram 3 for more detailed information
 ⁴⁾ See Diagram 13 for more detailed information

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¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Davamatan | C. makes | Values | | | 11 | |
|----------------------------------|----------------------|--------|--------------|--------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 25 | - | - | V | V _{GS} =0 V, <i>I</i> _D =1 mA |
| Gate threshold voltage | V _{GS(th)} | 1.0 | 1.5 | 2.0 | V | $V_{\rm DS}=V_{\rm GS}, I_{\rm D}=250~\mu {\rm A}$ |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1.0 100 | μA | V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =16 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 0.40 0.54 | 0.45 0.85 | mΩ | V _{GS} =10 V, <i>I</i> _D =30 A V _{GS} =4.5 V, <i>I</i> _D =30 A |
| Gate resistance | R _G | - | 0.7 | - | Ω | - |
| Transconductance | $g_{ m fs}$ | - | 230 | - | S | <i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =30 A |

Table 5Dynamic characteristics

| | Course has l | | Values | | | |
|------------------------------|--------------------|------|--------|------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance | C _{iss} | - | 11000 | - | pF | V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz |
| Output capacitance | Coss | - | 3600 | - | pF | V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance | Crss | - | 3100 | - | pF | V _{GS} =0 V, V _{DS} =12.5 V, <i>f</i> =1 MHz |
| Turn-on delay time | t _{d(on)} | - | 28 | - | ns | $V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | tr | - | 88 | - | ns | $V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{\rm d(off)}$ | - | 68 | - | ns | $V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 93 | - | ns | $V_{\rm DD}$ =12.5 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω |

Table 6 Gate charge characteristics¹⁾

| D | Ok. a l | Values | | | | |
|--------------------------|----------------------|--------|------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 24 | - | nC | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge at threshold | Q _{g(th)} | - | 15 | - | nC | V _{DD} =12.5 V, <i>I</i> _D =30 A, <i>V</i> _{GS} =0 to 4.5 V |
| Gate to drain charge | Q _{gd} | - | 69 | - | nC | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Switching charge | Q _{sw} | - | 78 | - | nC | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total | Qg | - | 135 | - | nC | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate plateau voltage | V _{plateau} | - | 2.2 | - | V | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 4.5 V |
| Gate charge total | Qg | - | 238 | - | nC | V_{DD} =12.5 V, I_{D} =30 A, V_{GS} =0 to 10 V |
| Output charge | Qoss | - | 70 | - | nC | V _{DS} =12.5 V, V _{GS} =0 V |

¹⁾ See "Gate charge waveforms" for parameter definition

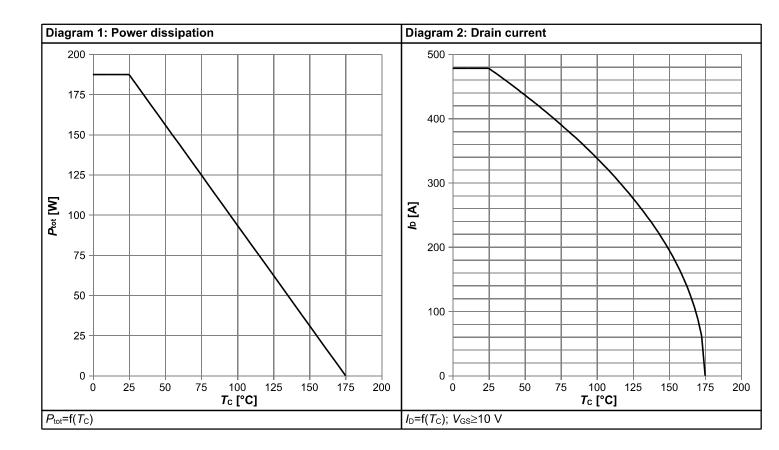


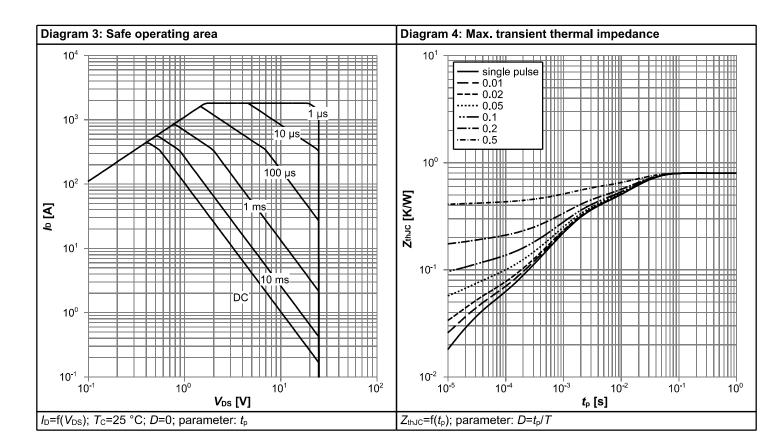
Table 7Reverse diode

| Peremeter | Symbol | Values | | | Unit | Note / Test Condition | |
|----------------------------------|----------------------|--------|------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | | Note / Test Condition | |
| Diode continuous forward current | ls | - | - | 188 | А | <i>T</i> _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 1914 | А | <i>T</i> _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.77 | 1.0 | V | V _{GS} =0 V, <i>I</i> _F =30 A, <i>T</i> _j =25 °C | |
| Reverse recovery charge | Qrr | - | 30 | - | nC | V _R =12.5 V, <i>I</i> _F = <i>I</i> _S , d <i>i</i> _F /d <i>t</i> =400 A/µs | |

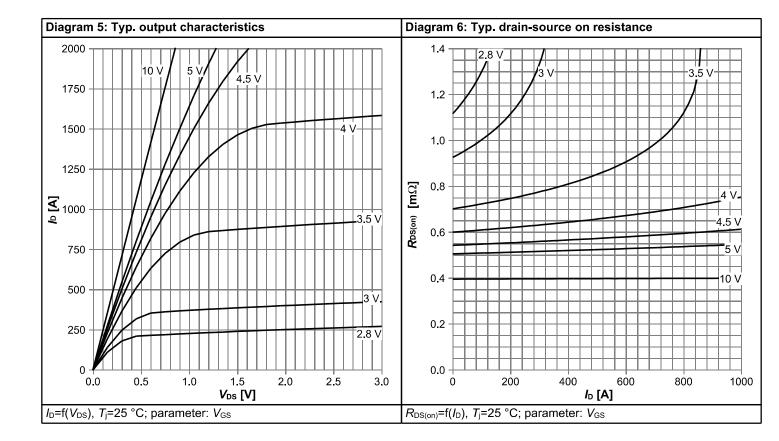


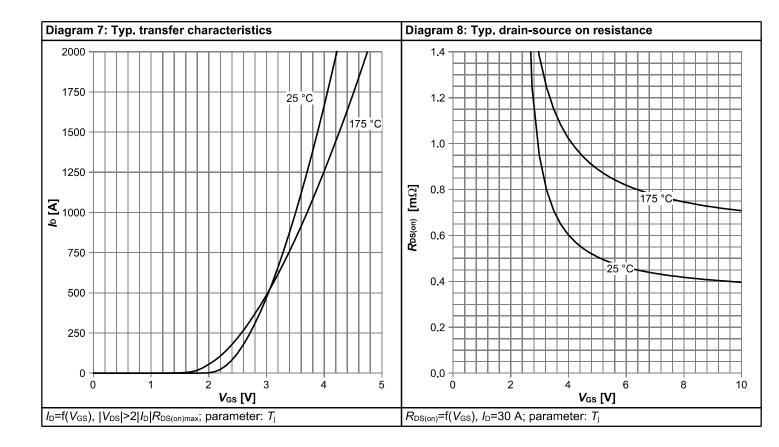
4 Electrical characteristics diagrams



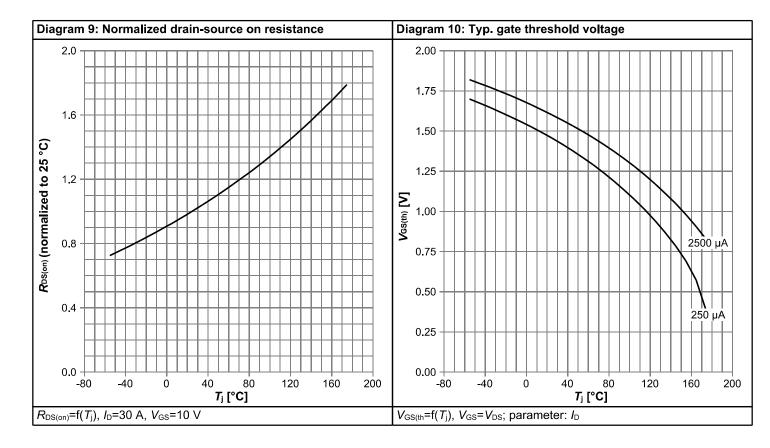


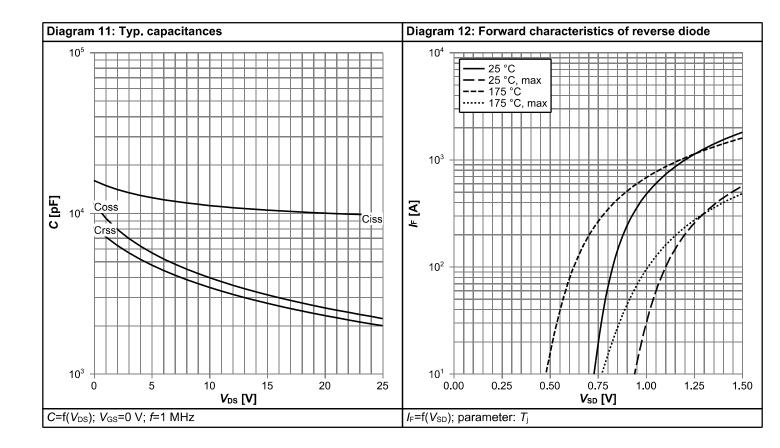




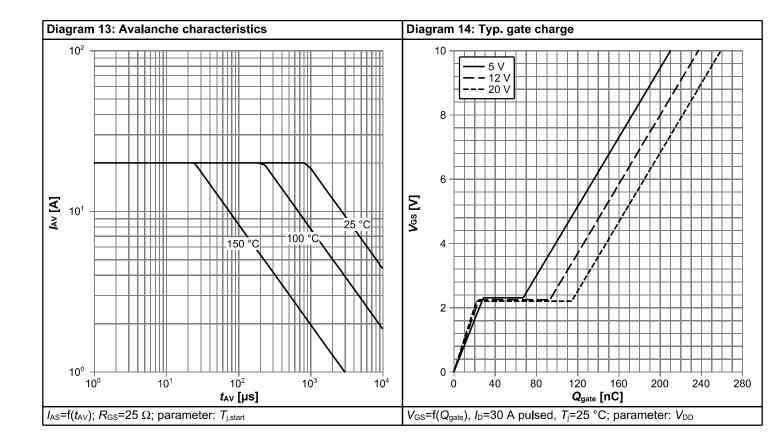


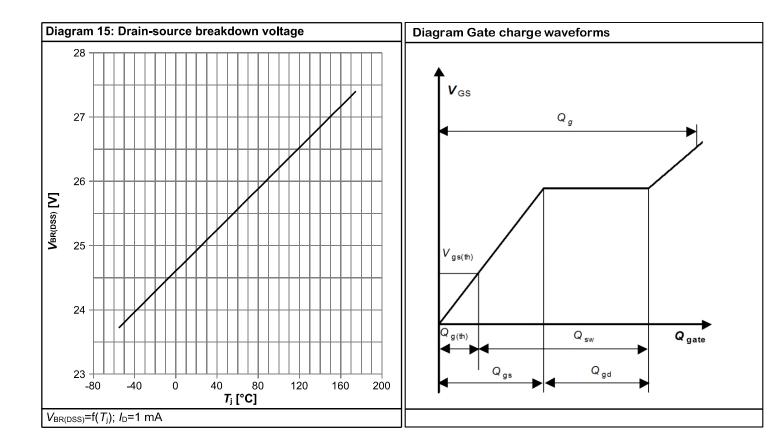






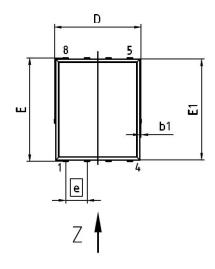


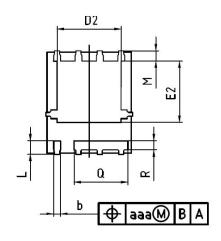


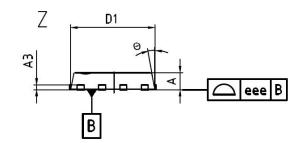




5 Package Outlines







| DIM | MILLIN | MILLIMETERS | | HES | DOCUMENT NO. |
|-----|--------|-------------|-------------|-------|---------------------|
| DIM | MIN | MAX | MIN | MAX | Z8B00162237 |
| A | 0.90 | 1.10 | 0.035 | 0.043 | |
| A3 | 0.25 | (REF) | 0.011 | (REF) | SCALE 03 |
| b | 0.34 | 0.54 | 0.013 | 0.021 | |
| b1 | 0.02 | 0.22 | 0.001 | 0.009 | 2.5 |
| D | 5.15 | (BSC) | 0.203 | (BSC) | |
| D1 | 5.00 | (BSC) | 0.197 | (BSC) | 0 2.5 |
| D2 | 3.70 | 4.40 | 0.146 | 0.173 | 5mm |
| E | 6.15 | (BSC) | 0.242 | (BSC) | |
| E1 | 6.00 | (BSC) | 0.236 (BSC) | | EUROPEAN PROJECTION |
| E2 | 3.40 | 3.80 | 0.134 | 0.150 | EUROPEAN PROJECTION |
| e | 1.27 | (BSC) | 0.050 | (BSC) | |
| N | | 8 | 8 | | |
| L | 0.74 | 0.84 | 0.029 | 0.033 | |
| М | 0.45 | 0.66 | 0.018 | 0.026 | |
| Θ | 8.5° | 12° | 8.5° | 12° | ISSUE DATE |
| Q | 3.15 | 3.25 | 0.124 | 0.128 | 02-08-2011 |
| R | 0.48 | 0.58 | 0.019 | 0.023 | |
| aaa | 0. | 25 | 0.010 | | REVISION |
| eee | 0. | 08 | 0.0 | 003 | 01 |

Figure 1 Outline PG-TDSON-8 FL, dimensions in mm/inches



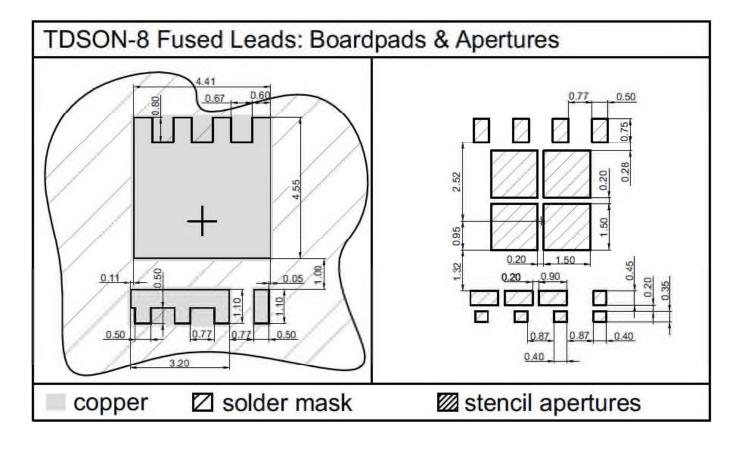


Figure 2 Outline Boardpads (TDSON-8 FL)



Revision History

BSC004NE2LS5

Revision: 2021-03-08, Rev. 2.1

| Previous Revision | | | | | | |
|-------------------|------------|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | |
| 2.0 | 2020-04-23 | Release of final version | | | | |
| 2.1 | 2021-03-08 | Update Id condition for EAS and VGS(th) | | | | |

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